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# 2SK1165, 2SK1166

Silicon N-Channel MOS FET

# HITACHI

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## Application

High speed power switching

## Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

## Outline

TO-3P



## 2SK1165, 2SK1166

### Absolute Maximum Ratings (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1165	$V_{DSS}$	450	V
	2SK1166		500	
Gate to source voltage		$V_{GSS}$	±30	V
Drain current		$I_D$	12	A
Drain peak current		$I_{D(pulse)}^{*1}$	48	A
Body to drain diode reverse drain current		$I_{DR}$	12	A
Channel dissipation		$Pch^{*2}$	100	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Notes: 1.  $PW \leq 10 \mu s$ , duty cycle  $\leq 1\%$

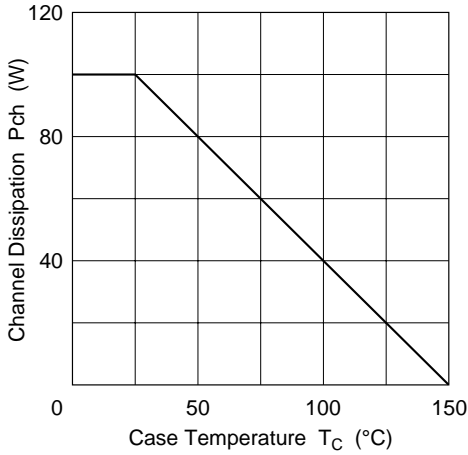
2. Value at  $T_c = 25^\circ C$

**Electrical Characteristics (Ta = 25°C)**

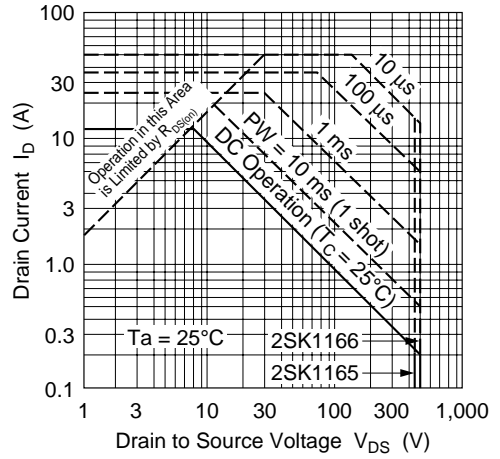
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	2SK1165 $V_{(BR)DSS}$ 2SK1166	450 500	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±30	—	—	V	$I_G = \pm 100 \mu\text{A}, V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	±10	μA	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	2SK1165 $I_{DSS}$ 2SK1166	—	—	250	μA	$V_{DS} = 360 \text{ V}, V_{GS} = 0$ $V_{DS} = 400 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	—	3.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static Drain to source on state resistance	2SK1165 $R_{DS(on)}$ 2SK1166	—	0.40 0.45	0.55 0.60	Ω	$I_D = 6 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$
Forward transfer admittance	$ y_{fs} $	6.0	10	—	S	$I_D = 6 \text{ A}, V_{DS} = 10 \text{ V}^{*1}$
Input capacitance	$C_{iss}$	—	1450	—	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	$C_{oss}$	—	410	—	pF	$f = 1 \text{ MHz}$
Reverse transfer capacitance	$C_{rss}$	—	55	—	pF	
Turn-on delay time	$t_{d(on)}$	—	20	—	ns	$I_D = 6 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	$t_r$	—	70	—	ns	$R_L = 5 \Omega$
Turn-off delay time	$t_{d(off)}$	—	120	—	ns	
Fall time	$t_f$	—	60	—	ns	
Body to drain diode forward voltage	$V_{DF}$	—	1.0	—	V	$I_F = 12 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	$t_{rr}$	—	450	—	ns	$I_F = 12 \text{ A}, V_{GS} = 0,$ $di_p/dt = 100 \text{ A}/\mu\text{s}$

Note: 1. Pulse test

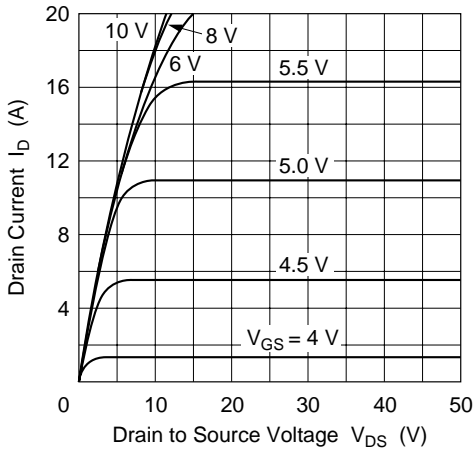
Power vs. Temperature Derating



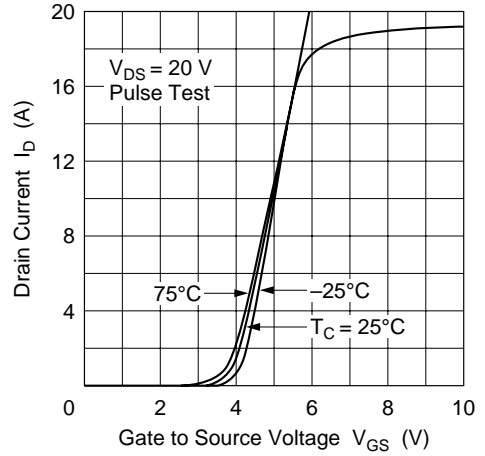
Maximum Safe Operation Area

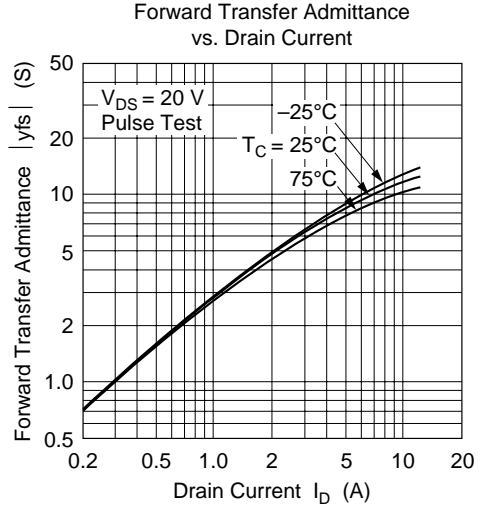
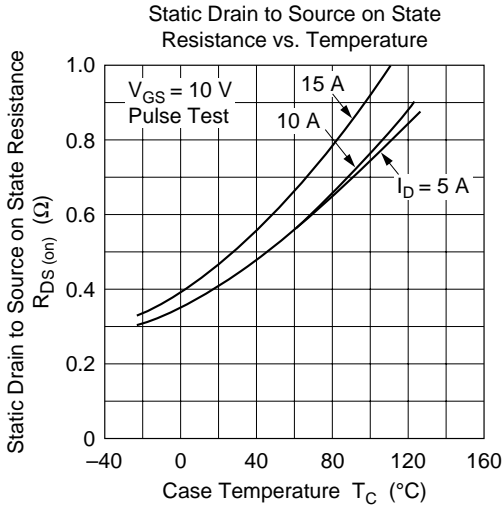
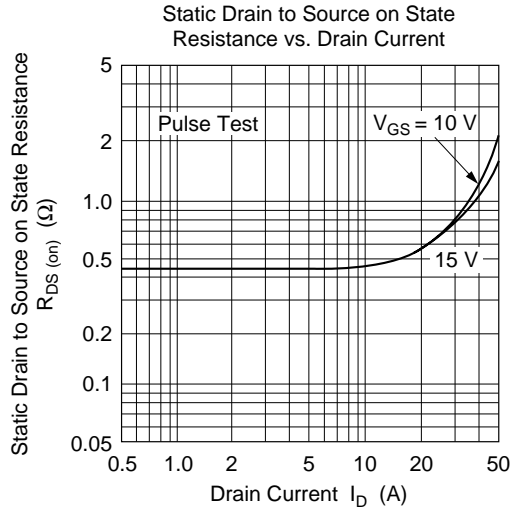
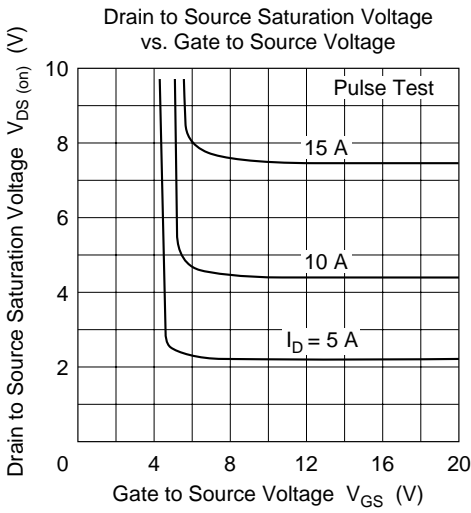


Typical Output Characteristics

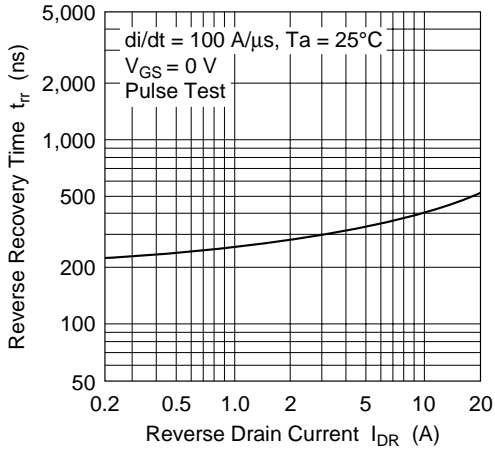


Typical Transfer Characteristics

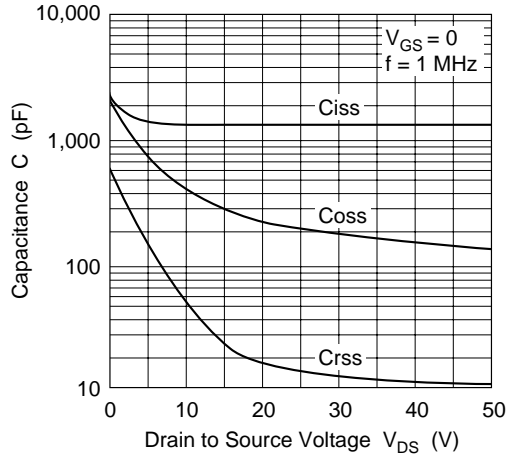




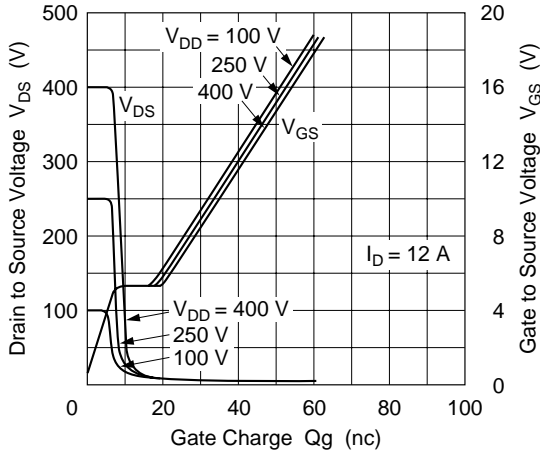
Body to Drain Diode Reverse Recovery Time



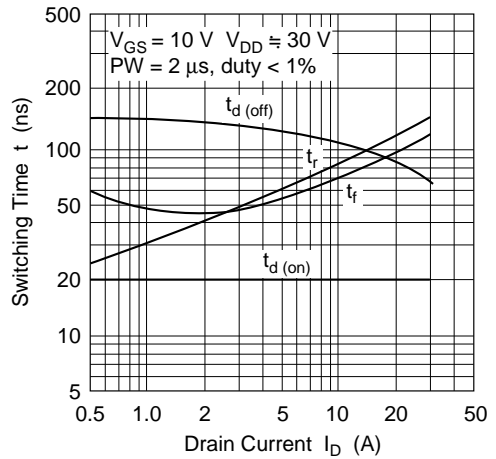
Typical Capacitance vs. Drain to Source Voltage

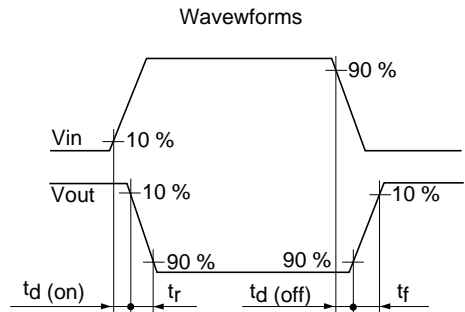
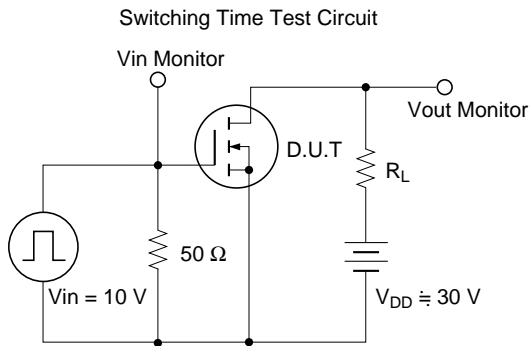
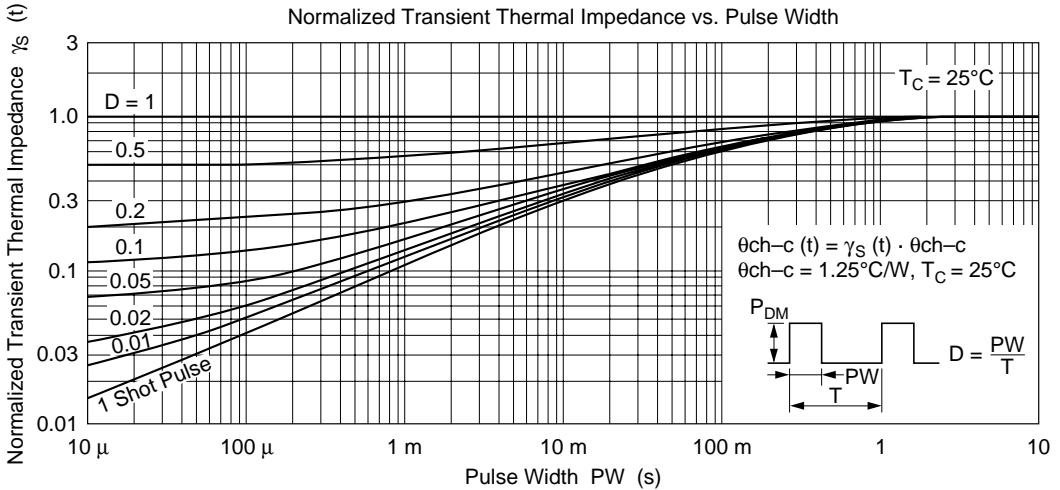
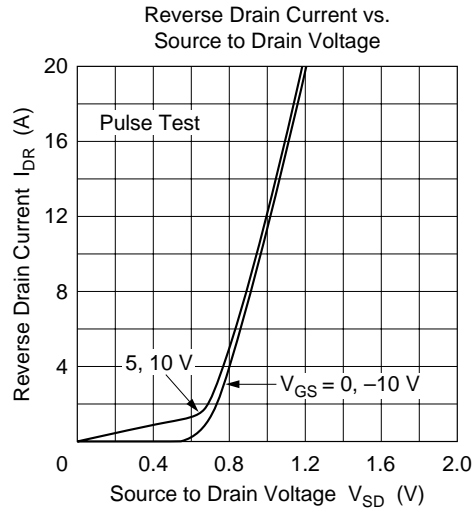


Dynamic Input Characteristics



Switching Characteristics







Hitachi Code	TO-3P
JEDEC	—
EIAJ	Conforms
Weight (reference value)	5.0 g



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